Form PTO-	1449		U.S. DEPARTMENT OF COMMERCE PATENT AND TRADEMARK OFFICE		ATTY. DOCKET NO. MI22-2383		Priori 10/271	Priority SERIAL NO. 10/271,888	
		LIST OF ART CITED (Use several sheets		NT	APPLICANT Fernando Gonzalez				
			Priority FILING D October 15, 2002		ATE Priority		y GROUP		
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EXAMINER Calvula DATE CONSIDERED 6.7.04									
*EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.									

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